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PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Docket No: Q65847

Tadaaki HARADA, *et al.*

Appln. No.: 09/914,363

Group Art Unit: 2826

Confirmation No.: 3899

Examiner: Leonardo ANDUJAR

Filed: August 27, 2001

For: RESIN COMPOSITION FOR SEMICONDUCTOR ENCAPSULATION,
SEMICONDUCTOR DEVICE COMPRISING THE SAME AND PROCESS FOR THE
PRODUCTION OF SEMICONDUCTOR DEVICE USING THE SAME

RESPONSE TO RESTRICTION REQUIREMENT

MAIL STOP AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

This is in response to the Office Action containing a restriction requirement mailed December 6, 2004. Applicants elect, without traverse, Group I, Claims 1-6 and 22, drawn to a resin composition. Applicants reserve the right to file a divisional application(s) directed to the non-elected subject matter.

The USPTO is directed and authorized to charge all required fees, except for the Issue Fee and the Publication Fee, to Deposit Account No. 19-4880. Please also credit any overpayments to said Deposit Account.

Respectfully submitted,

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WASHINGTON OFFICE

23373

CUSTOMER NUMBER

Date: December 22, 2004